

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	SK INNOVATION CO., LTD.	09/30/2018
RECEIVING PARTY DATA		
Name:	NEXFLEX CO., LTD.	
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State/Country:	KOREA, REPUBLIC OF	
PROPERTY NUMBERS Total: 5		
Property Type	Number	
Application Number:	12745712	
Application Number:	13328514	
Application Number:	15055932	
Application Number:	14369128	
Application Number:	14654795	
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SIGNATURE:	/Myung Soo KIM/	
DATE SIGNED:	10/02/2018	
Total Attachments: 2		
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ASSIGNMENT

WHEREAS SK INNOVATION CO., LTD., a corporation of Republic of Korea, whose post office address is 99, Seorin-dong, Jongno-gu, Seoul, Republic of Korea (hereinafter referred to as "Assignor"), owned the patents and/or patent applications in the list attached herewith (hereinafter referred as the "Patent(s)"),

BE IT KNOWN that, for good and valuable consideration, the receipt of which is hereby acknowledged, Assignor has sold, assigned, transferred, and set over, and does hereby sell, assign, transfer, and set over unto NEXFLEX CO., LTD., a corporation of the Republic of Korea, whose post office address is 153, Nonhyeon-ro, Seocho-gu, Seoul, Republic of Korea (hereinafter referred to as "Assignee"), its lawful successors and assigns Assignor's entire right, title, and interest in and to this application and the invention(s) and improvement(s) set forth therein; and any and all continuations, continuations-in-part, divisionals, and renewals of and substitutes for said application for said Patent(s) and any and all Patent(s) of the United States and of countries foreign thereto, which may be granted thereon or therefore; and any reissues, reexaminations, or extensions of all such Letters Patent.

Assignor HEREBY authorizes the Assignee, its lawful successors and assigns to apply for Letters Patent in all countries foreign to the United States directly in its own name, and to claim priority of the filing date of any of the above-mentioned applications for Letters Patent of the United States and of countries foreign thereto under the provisions of any and all international conventions and treaties.

Assignor HEREBY authorizes and requests the Commissioner of Patents and Trademarks of the United States and official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as foresaid, to issue all Letters Patent for the above-mentioned applications to the Assignee, its successors and assigns, in accordance with the terms of this Assignment;

Assignor HEREBY covenants that Assignor has the full right to convey the interest assigned by this Assignment, and Assignor has not executed and will not execute any agreement in conflict with this Assignment;

AND, Assignor HEREBY further covenants and agrees that Assignor will, without further consideration, communicate with said Assignee, its successors and assigns, any facts known to Assignor respecting the Patent(s), above-mentioned applications and above-mentioned Letters Patent and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to the Patent(s), above-mentioned applications and above-mentioned Letters Patent in said Assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid said Assignee, its successors and assigns, to obtain and enforce proper patent protection for the Patent(s), above-mentioned applications and above-mentioned Letters Patent in the United States and in countries foreign thereto, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

Date: Sep. 30, 2018

Doh Lee
Name: DOH LEE
Title: Team Leader
SK INNOVATION CO., LTD.

Assigned Patent Applications
from SK INNOVATION CO., LTD. to (NEXFLEX CO., LTD.)

Country	Application No.	Filing date	Patent No.	Registration Date
US	12/745,712	June 2, 2010	8,318,315	November 27, 2012
US	13/328,514	December 16, 2011	9,296,015	March 29, 2016
US	15/055,932	February 29, 2016	N/A	N/A
US	14/369,128	June 26, 2014	9,232,660	January 5, 2016
US	14/654/795	June 22, 2015	N/A	N/A